APA750-FG676 Information

Part Number	APA750-FG676	
Manufacturer	Microsemi Corporation	
Category	Integrated Circuits (ICs)	
	Embedded - FPGAs (Field Programmable Gate Array)	
Description	IC FPGA 454 I/O 676FBGA	
Package	676-BGA	

For Reference Only

For the pricing/inventory/lead time, please contact us
Website: https://www.heisener.com
E-mail: salesdept@heisener.com

Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.

APA750-FG676 Specifications

Manufacturer Part Number	APA750-FG676
Manufacturer	Microsemi Corporation
Category	Integrated Circuits (ICs)
	Embedded - FPGAs (Field Programmable Gate Array)
Package	676-BGA
Series	ProASICPLUS
Number of LABs/CLBs	-
Number of Logic Elements/Cells	-
Total RAM Bits	147456
Number of I/O	454
Number of Gates	750000
Voltage - Supply	2.3 V ~ 2.7 V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
	Report errors?

APA750-FG676 Guarantees

Quality Guarantees
We provide 90 days warranty. *
If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

Service Guarantees
We guarantee 100% customer satisfaction.
Our experienced sales team and tech support team back our services to satisfy all our customers.

APA750-FG676 Payment Methods

WIRE transfer   PayPal   WESTERN UNION WU moving money for better   MoneyGram   Alipay   VISA   MasterCard   AMERICAN EXPRESS   DISCOVER NETWORK   UnionPay

APA750-FG676 Shipping Methods

DHL   FedEx   UPS   TNT   EMS

If you have any question about APA750-FG676, please do not hesitate to contact us!
Website: https://www.heisener.com
E-mail: salesdept@heisener.com